



50V N-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

50 V

Current

350mA

Features

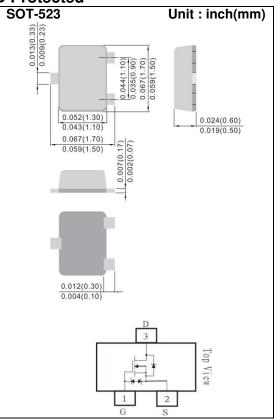
- RDS(ON), VGS@10V, ID@500mA<1.6Ω
- RDS(ON), VGS@4.5V, ID@200mA<2.5Ω
- RDS(ON), VGS@2.5V, ID@100mA<4.5Ω
- Advanced Trench Process Technology
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers: Relay, Displays, Memories, etc.
- ESD Protected 2KV HBM
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-523 Package

Terminals: Solderable per MIL-STD-750, Method 2026

Approx. Weight: 0.00007 ounces, 0.002 grams



Maximum Ratings and Thermal Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V_{DS}	50	V
Gate-Source Voltage		V_{GS}	<u>+</u> 20	V
Continuous Drain Current		I _D	350	mA
Pulsed Drain Current		I _{DM}	1200	mA
Power Dissipation	T _A =25°C	P _D	223	mW
	Derate above 25°C		1.8	mW/°C
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55~150	°C
Typical Thermal resistance				
- Junction to Ambient (Note 3)		$R_{\theta JA}$	560	°C/W





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =250uA	50	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	0.8	1.0	1.5	V
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS}=10V,I_{D}=500mA$	-	0.96	1.6	Ω
		V _{GS} =4.5V,I _D =200mA	-	1.25	2.5	
		V _{GS} =2.5V,I _D =100mA	-	2.73	4.5	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =50V, V_{GS} =0V	-	0.01	1	uA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\underline{+}20V, V_{DS}=0V$	-	<u>+</u> 3.0	<u>+</u> 10	uA
Dynamic						
Total Gate Charge	Q_g	V _{DS} =25V, I _D =250mA, V _{GS} =4.5V ^(Note 1,2)	-	0.63	1	nC
Gate-Source Charge	Q_{gs}		-	0.2	-	
Gate-Drain Charge	Q_gd		-	0.23	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V,	-	25	50	pF
Output Capacitance	Coss		-	9.5	20	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	2.1	5	
Switching						
Turn-On Delay Time	td _(on))/ OF)/ F00 A	-	2.2	5	ns
Turn-On Rise Time	tr	V_{DD} =25V, I_{D} =500mA, V_{GS} =10V, R_{G} =6 Ω (Note 1,2)	-	19.2	38	
Turn-Off Delay Time	td _(off)		-	6.2	12	
Turn-Off Fall Time	tf	H _G =012	-	23	50	
Drain-Source Diode						
Maximum Continuous Drain-Source	I _S		_	-	500	mA
Diode Forward Current	ıs		_			
Diode Forward Voltage	V_{SD}	I _S =500mA, V _{GS} =0V	-	0.86	1.5	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. mounted on a 1 inch square pad of copper





TYPICAL CHARACTERISTIC CURVES

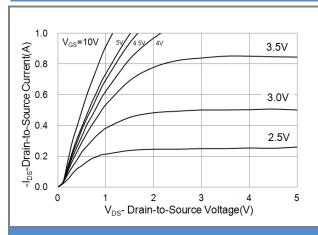


Fig.1 On-Region Characteristics

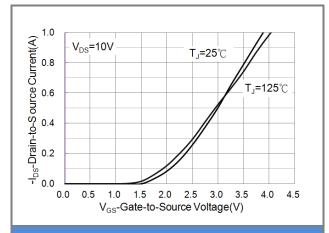


Fig.2 Transfer Characteristics

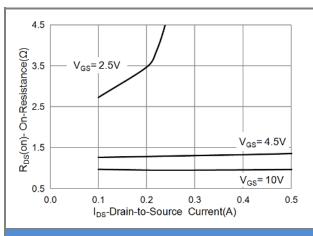


Fig.3 On-Resistance vs. Drain Current

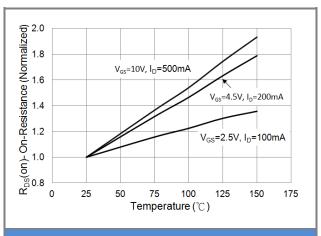


Fig.4 On-Resistance vs. Junction temperature

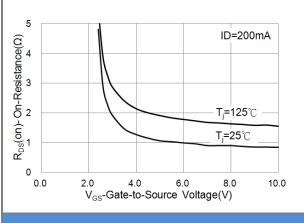


Fig.5 On-Resistance Variation with VGS.

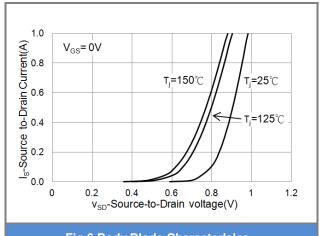


Fig.6 Body Dlode CharacterIslcs





TYPICAL CHARACTERISTIC CURVES

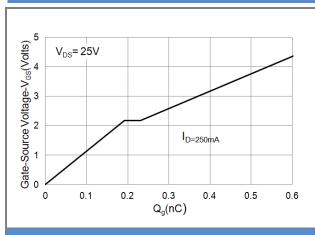


Fig.7 Gate-Charge Characteristics

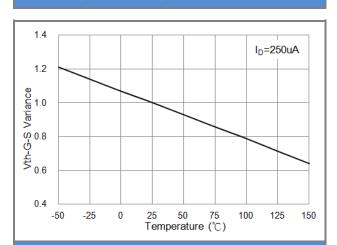


Fig.9 Threshold Voltage Variation with Temperature.

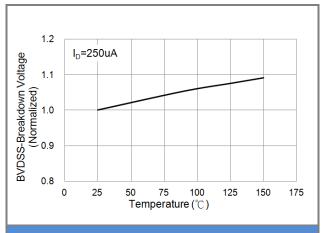


Fig.8 Breakdown Voltage Variation vs. Temperature

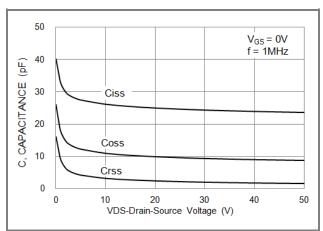


Fig.10 Capacitance vs. Drain-Source Voltage.

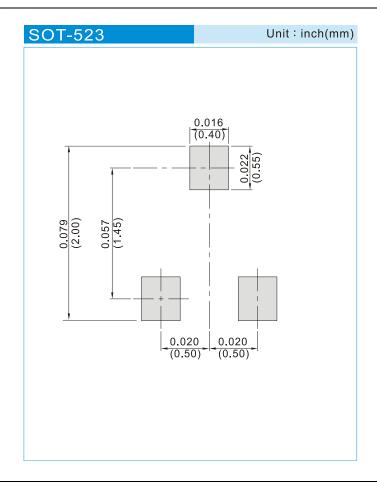




PART NO PACKING CODE VERSION

PART NO PACKING CODE VERSION	Package Type	Packing type	Marking	Version	
PJE138K_R1_00001	SOT-523	4K pcs / 7" reel	8KT	Halogen free	

MOUNTING PAD LAYOUT







Disclaimer

- Reproducing and modifying information of the document is prohibited without permission from Panjit International Inc..
- Panjit International Inc. reserves the rights to make changes of the content herein the document anytime without notification. Please refer to our website for the latest document.
- Panjit International Inc. disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially occurred.
- Panjit International Inc. does not assume any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.
- Applications shown on the herein document are examples of standard use and operation. Customers are
 responsible in comprehending the suitable use in particular applications. Panjit International Inc. makes no
 representation or warranty that such applications will be suitable for the specified use without further testing or
 modification.
- The products shown herein are not designed and authorized for equipments requiring high level of reliability or relating to human life and for any applications concerning life-saving or life-sustaining, such as medical instruments, transportation equipment, aerospace machinery et cetera. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panjit International Inc. for any damages resulting from such improper use or sale.
- Since Panjit uses lot number as the tracking base, please provide the lot number for tracking when complaining.